



SCHOTTKY BARRIER RECTIFIER

SR502 THRU SR510

VOLTAGE RANGE
CURRENT

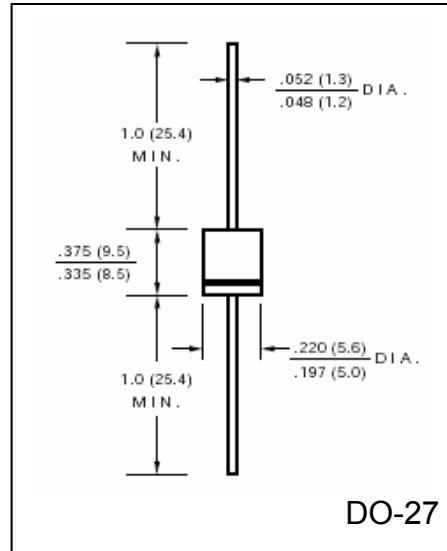
20 to 100Volts
5.0 Ampere

FEATURES

- Fast switching
- Low forward voltage
- Low power loss for high efficiency
- High Surge capability
- High temperature Soldering guaranteed:
250 °C/10 seconds, 0.373" (9.5mm) lead length

MECHANICAL DATA

- Case: Transfer molded plastic
- Epoxy: UL94V-0 rate flame retardant
- Lead: Solderable per MIL-STD-202E method 208C
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.042 ounce, 1.19 gram



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

- Ratings at 25°C ambient temperature unless otherwise specified
- Single Phase, half wave, 60Hz, resistive or inductive load
- For capacitive load derate current by 20%

| | SYMBOLS | SR502 | SR503 | SR504 | SR505 | SR506 | SR508 | SR510 | UNIT |
|--|-------------------|-------|-------|---------------|-------|-------|-------|-------|-------|
| Maximum Repetitive Peak Reverse Voltage | V _{RRM} | 20 | 30 | 40 | 50 | 60 | 80 | 100 | Volts |
| Maximum RMS Voltage | V _{RMS} | 14 | 21 | 28 | 35 | 42 | 56 | 70 | Volts |
| Maximum DC Blocking Voltage | V _{DC} | 20 | 30 | 40 | 50 | 60 | 80 | 100 | Volts |
| Maximum Average Forward Rectified Current, 0.375" (9.5mm) lead length , (Note 1) , see Fig. 1 | I _(AV) | | | | | 5.0 | | | Amps |
| Peak Forward Surge Current 8.3mS single half sine wave superimposed on rated load (JEDEC method) | I _{FSM} | | | | | 150 | | | Amps |
| Maximum Instantaneous Forward Voltage @ 5.0A | V _F | | 0.57 | | 0.75 | | 0.85 | | Volts |
| Maximum DC Reverse Current at Rated T _A = 25 °C | I _R | | | 0.5 | | | | | mA |
| DC Blocking Voltage per element (Note 1) T _A = 100 °C | | | | 50 | | | | | |
| Typical Junction Capacitance (Measured at 1.0MHz and applied reverse voltage of 4.0V) | C _J | | 550 | | 450 | | 350 | | pF |
| Typical Thermal Resistance (Note 2) | R _{θJA} | | | 25 | | | | | °C/W |
| Operating Junction Temperature Range | T _J | | | (-55 to +150) | | | | | °C |
| Storage Temperature Range | T _{STG} | | | (-55 to +150) | | | | | °C |

Notes:

1. Pulse test: 300μS pulse width, 1% duty cycle
2. Thermal resistance from junction to ambient PCB mounted with 0.375" (9.5mm) lead length with 2.5" x 2.5" (63.5cm x 63.5cm) copper pads

RATINGS AND CHARACTERISTIC CURVES SR502 THRU SR510

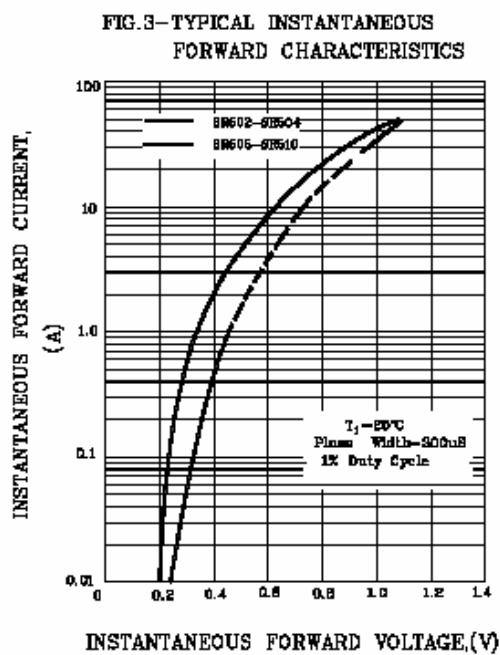
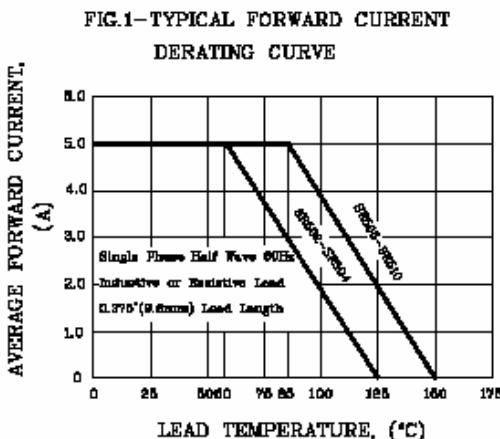


FIG.5—TYPICAL JUNCTION CAPACITANCE

